





#### COMPLEMENTARY OUTPUT HALL EFFECT LATCH

#### **Description**

AH276 are integrated Hall sensors with output drivers, mainly designed for electronic commutation of brush-less DC Fan. This IC internally includes the regulator, protecting diode, Hall plate, amplifier, comparator, and a pair of complementary open-collector outputs (DO,

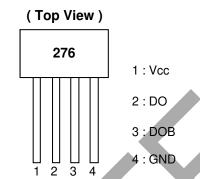
While the magnetic flux density (B) is larger than operate point (Bop), DO will turn on (low), and meanwhile DOB will turn off (high). Each output is latched until B is lower than release point (Brp), and then DO, DOB transfer each state.

For DC fan application, sometimes need to test power reverse connection condition. Internal diode only protects chip-side but not for coil-side. If necessary, add one external diode to block the reverse current from coil-side.

#### **Features**

- On-chip Hall sensor with two different sensitivity and hysteresis settings for AH276
- Built-in protecting diode only for chip reverse power connecting
- -20°C to +85°C operating temperature
- Lead Free Package: SIP-4L
- SIP-4L: Available in "Green" Molding Compound (No Br, Sb)
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

#### **Pin Assignments**



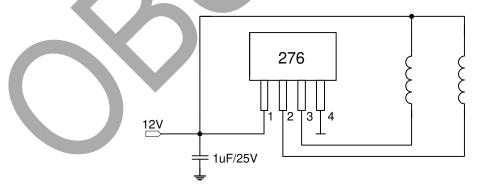
#### **Applications**

- Dual-coil Brush-less DC Motor
- Dual-coil Brush-less DC Fan
- **Revolution Counting**
- Speed Measurement

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
  2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

### Typical Applications Circuit



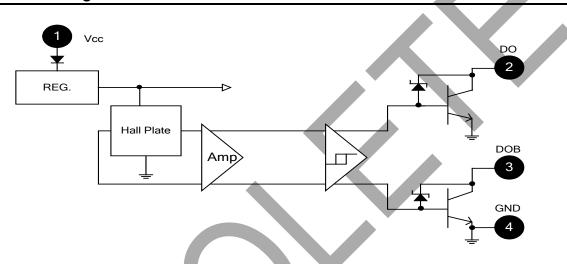
**Brush-less DC Fan** 



## **Pin Descriptions**

| Pin Name        | P/I/O | Pin# | Function           |
|-----------------|-------|------|--------------------|
| V <sub>CC</sub> | Р     | 1    | Power Supply Input |
| DO              | 0     | 2    | Output Pin         |
| DOB             | 0     | 3    | Output Pin         |
| GND             | Р     | 4    | Ground             |

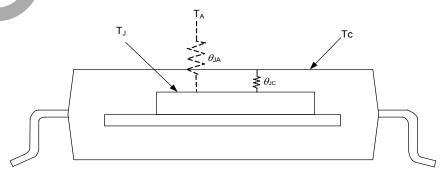
## **Functional Block Diagram**



# Absolute Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Symbol        | Par   | ameter          | Rating     | Unit  |
|---------------|---|-----------------|------------|-------|
| $V_{CC}$      | Supply Voltage                                  |                 | 20         | V     |
| $V_{RCC}$     | Reverse VCC Polarity Voltage                    |                 | -20        | V     |
| В             | Magnetic Flux Density                           |                 | Unlim      | nited |
|               | 0.1   | Continuous      | 0.4        |       |
| lo            | lo Output "on" Current (Note 3)                 | Hold            | 0.5        | Α     |
|               | (Note 3)  | Peak (Start Up) | 0.7        |       |
| Ts            | Storage Temperature Range                       | ·               | -65 ~ +150 | °C    |
| PD            | Package Power Dissipation (SI                   | P-4L)           | 550        | mW    |
| TJ            | Maximum Junction Temperature                    |                 | +150       | °C    |
| $\theta_{JA}$ | Thermal Resistance Junction-to-Ambient (SIP-4L) |                 | 227        | °C/W  |
| θус           | Thermal Resistance Junction-to                  | o-Case (SIP-4L) | 49         | °C/W  |

Note: 3. P<sub>D</sub> shall be within Safety Operation Area.





### Recommended Operating Conditions (@TA = +25°C, unless otherwise specified.)

| Symbol          | Parameter                     | Conditions | Min | Max | Unit |
|-----------------|-------------------------------|------------|-----|-----|------|
| V <sub>CC</sub> | Supply Voltage (Note 4)       | Operating  | 3.5 | 20  | V    |
| T <sub>A</sub>  | Operating Ambient Temperature | Operating  | -20 | +85 | °C   |

Note: 4. The output DO/DOB is switching as magnetic field change (S>300G, N<-300G).

### **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Symbol               | Parameter                 | Conditions                                   | Min | Тур  | Max | Unit |
|----------------------|---------------------------|--|-----|------|-----|------|
| Vz                   | Output Zener Breakdown    |  | l   | 35   | l   | V    |
| V <sub>CE(SAT)</sub> | Output Saturation Voltage | $V_{CC} = 14V, I_L = 400mA$                  | _   | 0.6  | 0.9 | V    |
| I <sub>CEX</sub>     | Output Leakage Current    | V <sub>CE</sub> = 14V, V <sub>CC</sub> = 14V | _   | <0.1 | 10  | μΑ   |
| Icc                  | Supply Current            | V <sub>CC</sub> = 20V, Output Open           | 7   | 16   | 25  | mA   |

### Magnetic Characteristics (Note 5) (@T<sub>A</sub> = +25°C, V<sub>CC</sub> = 14V, unless otherwise specified.)

#### A grade

| Symbol | Characteristic | Min | Тур | Max | Unit  |
|--------|----------------|-----|-----|-----|-------|
| Вор    | Operate Point  | 10  |     | 50  | Gauss |
| Brp    | Release Point  | -50 | _   | -10 | Gauss |
| Bhy    | Hysteresis     | _   | 75  |     | Gauss |

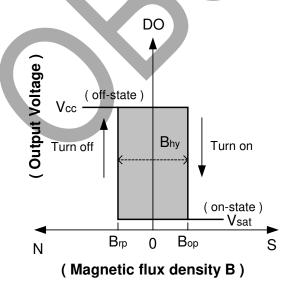
#### B grade

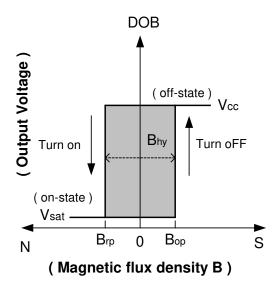
| Symbol | Characteristic | Min | Тур | Max | Unit  |
|--------|----------------|-----|-----|-----|-------|
| Вор    | Operate Point  | 5   | _   | 70  | Gauss |
| Brp    | Release Point  | -70 | _   | -5  | Gauss |
| Bhy    | Hysteresis     | _   | 75  |     | Gauss |

#### C grade

| Symbol | Characteristic | Min  | Тур | Max | Unit  |
|--------|----------------|------|-----|-----|-------|
| Вор    | Operate Point  | _    | _   | 100 | Gauss |
| Brp    | Release Point  | -100 | _   | _   | Gauss |
| Bhy    | Hysteresis     | _    | 75  | _   | Gauss |

Note: 5. Magnetic characteristics are for design information, which will vary with supply voltage, operating temperature and after soldering.

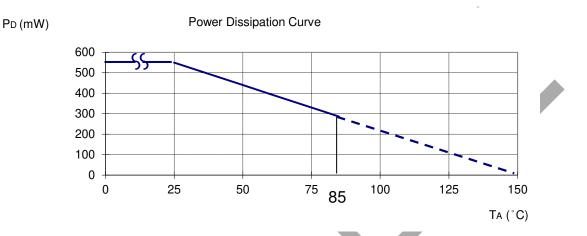




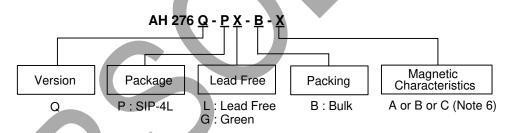


### **Performance Characteristics**

| T <sub>A</sub> (°C) | 25  | 50  | 60  | 70  | 80  | 85  | 90  | 95  | 100 |
|---------------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|
| P <sub>D</sub> (mW) | 550 | 440 | 396 | 352 | 308 | 286 | 264 | 242 | 220 |
| T <sub>A</sub> (°C) | 105 | 110 | 115 | 120 | 125 | 130 | 135 | 140 | 150 |
| P <sub>D</sub> (mW) | 198 | 176 | 154 | 132 | 110 | 88  | 66  | 44  | 0   |



# **Ordering Information**

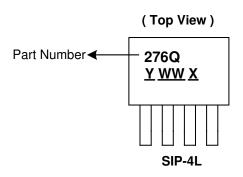


| Part Number   | Package | Packaging Bulk Ma |          | Magnetic           |                 |
|---------------|---------|-------------------|----------|--------------------|-----------------|
| Part Number   | Code    | Packaging         | Quantity | Part Number Suffix | Characteristics |
| AH276Q-PL-B-A | Р       | SIP-4L            | 1000     | -B                 | Α               |
| AH276Q-PL-B-B | Р       | SIP-4L            | 1000     | -B                 | В               |
| AH276Q-PL-B-C | Р       | SIP-4L            | 1000     | -B                 | С               |
| AH276Q-PG-B-A | Р       | SIP-4L            | 1000     | -B                 | Α               |
| AH276Q-PG-B-B | Р       | SIP-4L            | 1000     | -B                 | В               |
| AH276Q-PG-B-C | Р       | SIP-4L            | 1000     | -В                 | С               |

Note: 6. Please refer to page 3 (Magnetic Characteristics table).



### **Marking Information**



Y: Year: 0~9

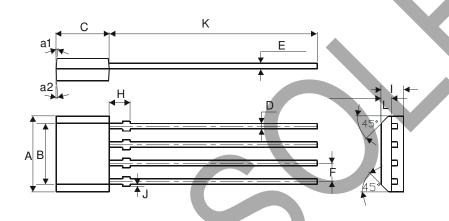
WW: Week: 01~52, "52" represents

52 and 53 week  $\underline{X}$ : Internal Code: a~z: Lead Free

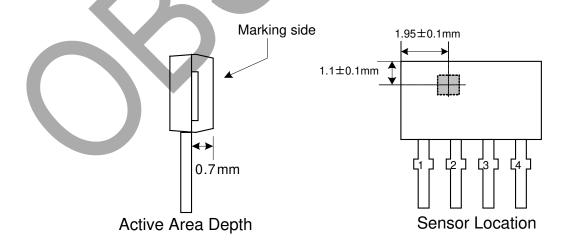
A~Z: Green

### Package Outline Dimensions (All dimensions in mm.)

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



|         | SIP-4         |       |  |  |
|---------|---------------|-------|--|--|
| Dim     | Min           | Max   |  |  |
| Α       | 5.12          | 5.32  |  |  |
| В       | 4.10          | 4.30  |  |  |
| С       | 3.55          | 3.75  |  |  |
| D       | <b>D</b> 0.38 |       |  |  |
| Е       | 0.35          | 0.41  |  |  |
| F       | 1.24          | 1.30  |  |  |
| Н       | 1.32          | 1.52  |  |  |
| I       | 1.45          | 1.65  |  |  |
| J       | 0.00          | 0.2   |  |  |
| K       | 13.00         | 15.5  |  |  |
| L       | 0.63          | 0.83  |  |  |
| a1      | 3°            | 5°    |  |  |
| a2      | 4°            | 7°    |  |  |
| All Dim | ensions       | in mm |  |  |





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